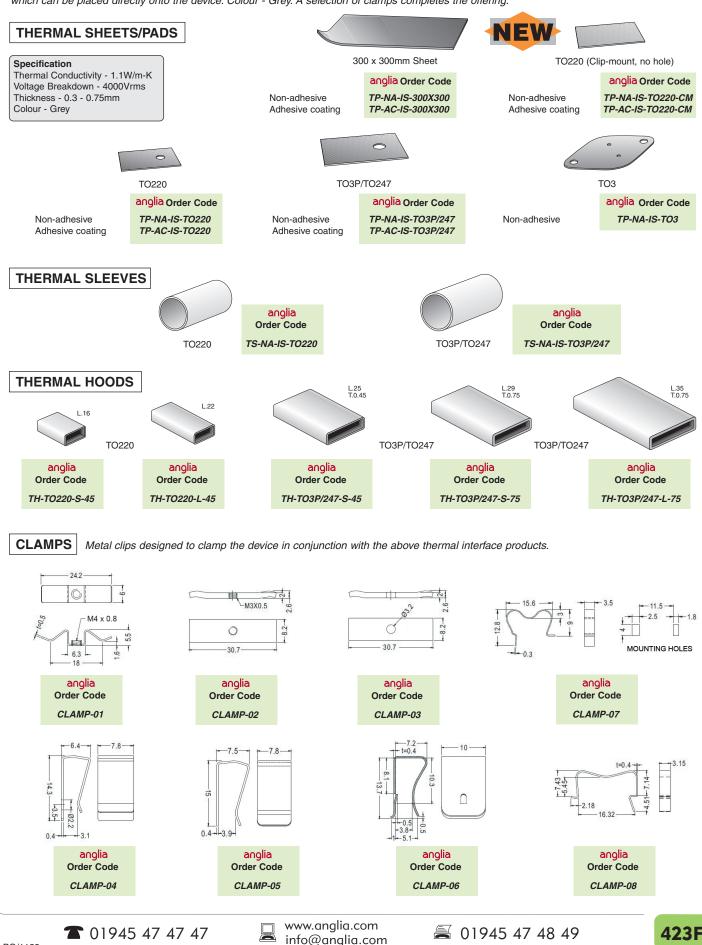
# Calinar THERMAL INTERFACE MATERIALS

# **HEATSINKS & MOUNTINGS**

A range of economical, commercial grade sillicone rubber thermal interface materials providing good electrical isolation, reinforced with glass fibre and flame retardant to UL94V-0. Supplied in sheets of 300 x 300mm or pre-cut pads. The range also includes thermal sleeves and hoods, which can be placed directly onto the device. Colour - Grey. A selection of clamps completes the offering.

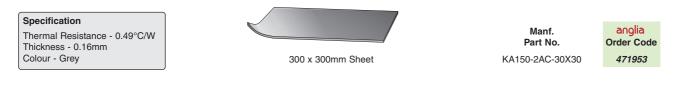


## **MOUNTING HARDWARE**

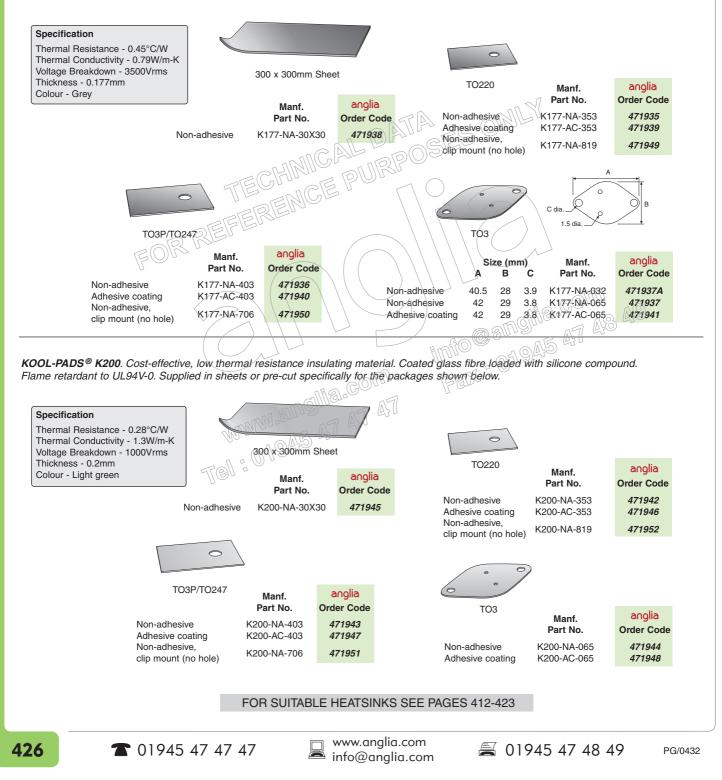


#### THERMAL INTERFACE MATERIALS

**KOOL-PADS® KA150-2AC**. Provides an efficient method of mounting heatsinks on to devices such as CPUs, DIL/SMT packages and other similar devices requiring effective transfer of generated heat. Highly conductive aluminium foil with adhesive applied to both sides negates the need for clips or any other form of mechanical fixing in applications where electrical isolation is **not** required. Supplied in 300 x 300mm sheets.



KOOL-PADS<sup>®</sup> K177. Silicone rubber compound coated on to a layer of woven glass fibre, providing a strong and flexible insulator which will not crack, age or become contaminated. Flame retardant to UL94V-0. Supplied in sheets or pre-cut specifically for the packages shown below.

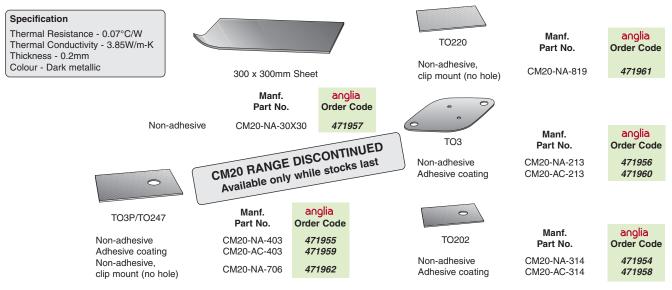




#### THERMAL INTERFACE MATERIALS

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**KOOL-PADS**<sup>®</sup> **CM20**. 98% graphite offering a dry alternative to thermal compounds. Designed for high power applications where electrical isolation is **not** required. Supplied in sheets or pre-cut specifically for the packages shown below.



**THERMAFLEX**<sup>®</sup> tube is designed to be slipped over the device before clip application. Gives good thermal performance and high levels of electrical isolation. Supplied specifically for the packages shown below.



CLIPS					
			Suitabili	Manf. ty Part No.	anglia Order Code
	Suitable for use with panels up to 1.2mm and pads up to 0 thickness. Max. force = 5.5kg. Zinc plated with clear passiv		TO220	TSC802	471963
QŪ	Nylon coated gull wing clip for retaining <b>two</b> devices onto a pad thickness. Max. force = 7.5kg/device. Gives up to 3500 from transistor tab. Centre screw mounting.		TO220	TSC607-NY	471965
	Gull wing clip designed for use with KOOL-PAD <sup>®</sup> K177/20 any panel. Max. force = 12kg. Zinc plated with clear passiv Max. isolation 1000V from transistor tab. Screw mounting.		TO220	TSC209-ZP	471967
b	Industry standard clip for retaining TO220 or similar device heatsinks.	es to custom	TO220	CLP-101	CLP-101
	Suitable for use with panels up to 2mm and pads up to 0.2 Max. force = 10kg. Zinc plated with clear passivated finish.		TO3P/TO2	247 TSC903	471964
	Nylon coated gull wing clip for retaining <b>two</b> devices onto any panel or pad thickness. Max. force = 11kg/device. Gives up to 3500V isolation from transistor tab. Centre screw mounting.		TO3P/TO2	247 TSC506-NY	471966
	Gull wing clip designed for use with KOOL-PAD <sup>®</sup> K177/200-NA-706 on any panel. Max. force = 15kg. Zinc plated with clear passivated finish. Max. isolation 1000V from transistor tab. Screw mounting.		TO3P/TO2	247 TSC405-ZP	471968
INSULA		0.11.1.11		Manf. Part No.	anglia Order Code
Comprise of a	a silicone insulating washer and bush(es).	Suitabilit			
		TO220 (fixing	,	K177-353BQ2840	471930
		TO3P or TO3P/TO2	,	K177-235BQ35 K177-872BQ35	471933 471934
		103P/10	241	N1//-0/2DQ35	47 1934

TO3<sup>†</sup>

TO126

† CEL version also available (see page 425). Please specify preferred supplier when ordering.

FOR SUITABLE HEATSINKS SEE PAGES 412-423

Bergquist Thermal Interface Materials shown overleaf > > > >

471931

471932

**T** 01945 47 47 47

www.anglia.com info@anglia.com

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K177-065BQ35

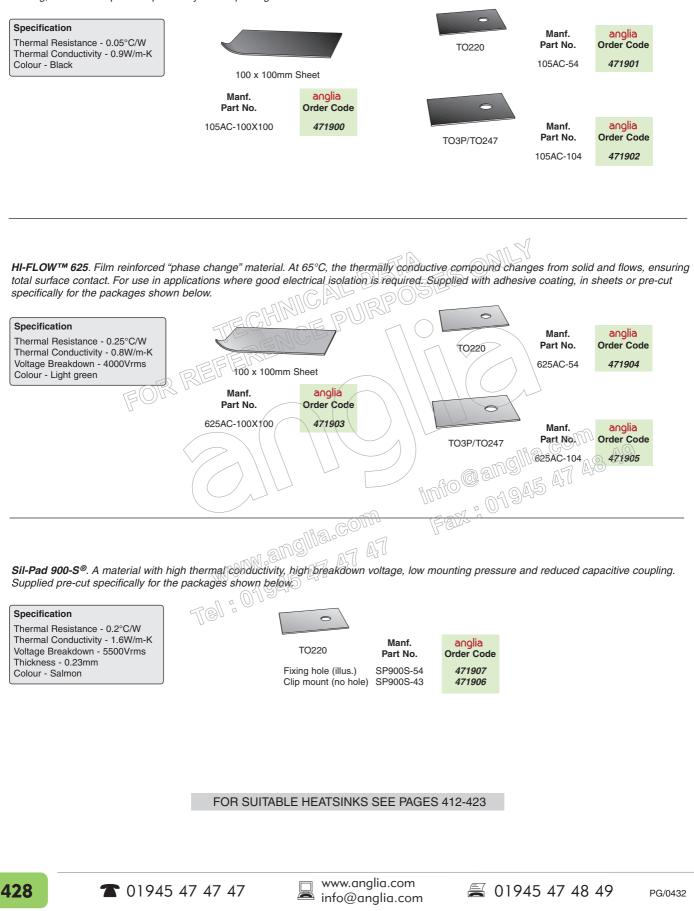
K177-679BQ57

### **MOUNTING HARDWARE**

### BERGQUIST

#### THERMAL INTERFACE MATERIALS

HI-FLOW™ 105. "Phase change" polymer coated aluminium designed to replace grease as a thermal interface. For use in applications where electrical isolation is **not** required. At 65°C, Hi-Flow changes from solid and flows, ensuring total surface contact. Supplied with adhesive coating, in sheets or pre-cut specifically for the packages shown below.



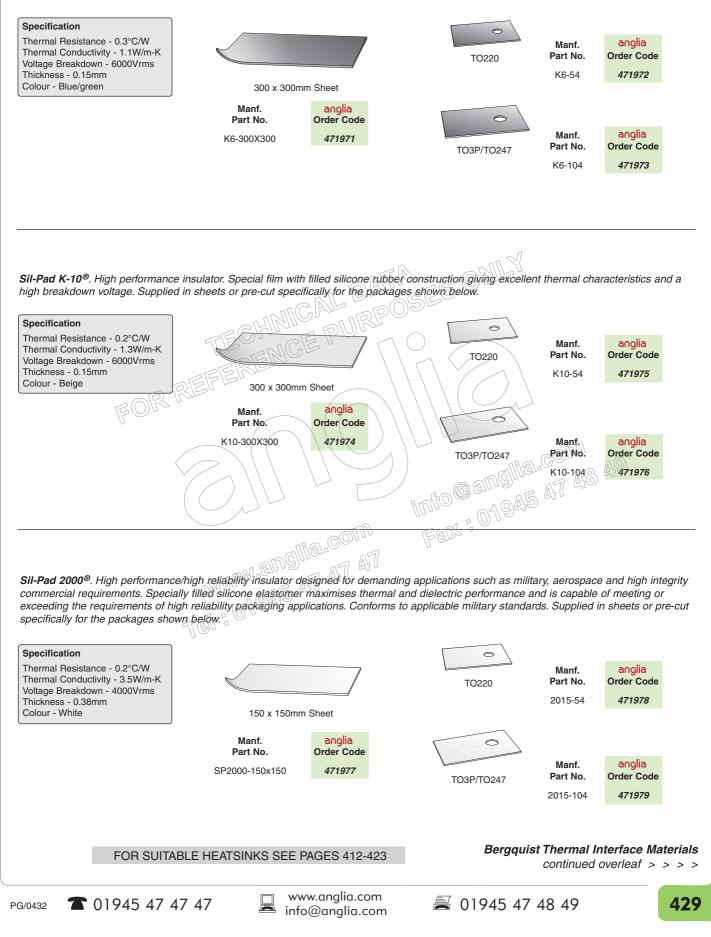
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**HEATSINKS & MOUNTINGS** MOUNTING HARDWARE

#### THERMAL INTERFACE MATERIALS

continued

Sil-Pad K-6<sup>®</sup>. Silicone elastomer coated, thermally conductive medium performance insulator. Puncture resistant with a high breakdown voltage. Supplied in sheets or pre-cut specifically for the packages shown below.



**MOUNTING HARDWARE** 

### EERGQUIST



**Q-Pad 3**<sup>®</sup>. Elastomer coated, glass fibre reinforced interface designed to conform to the clamping surface textures, creating an air free environment. The material offers good thermal characteristics in applications where electrical isolation is **not** required. Supplied with adhesive coating, in sheets or pre-cut specifically for the packages shown below.

